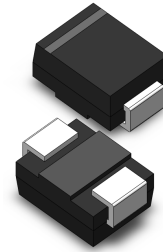


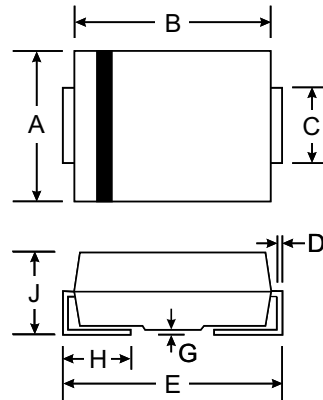
### Features

- 50A Peak Pulse Current @ 10/1000 s
- 250A Peak Pulse Current @ 8/20 s
- 58 - 320V Stand-Off Voltages
- Oxide-Glass Passivated Junction
- Bi-Directional Protection In a Single Device
- High Off-State impedance and Low On-State Voltage



### Mechanical Data

- Case: SMB/DO-214AA, Molded Plastic
- Terminals: Solder Plated, Solderable per MIL-STD-750, Method 2026
- Polarity: Cathode Band or Cathode Notch
- Marking: Type Number
- Weight: 0.093 grams (approx.)



SMB(DO-214AA)		
Dim	Min	Max
A	3.30	3.94
B	4.06	4.70
C	1.91	2.21
D	0.15	0.31
E	5.00	5.59
G	0.10	0.20
H	0.76	1.52
J	2.00	2.62
All Dimensions in mm		

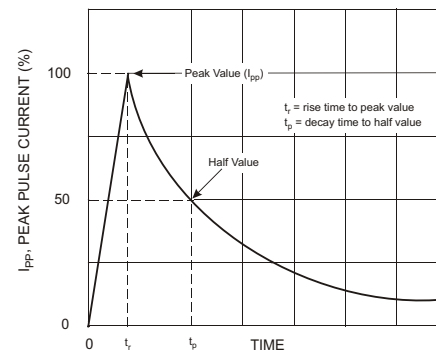
### Maximum Ratings @ T<sub>A</sub> = 25 °C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Impulse Current @ 10/1000us	I <sub>pp</sub>	50	A
Non-Repetitive Peak On-State Current @ 8.3ms (one-half cycle)	I <sub>TSM</sub>	30	A
Junction Temperature Range	T <sub>j</sub>	-40 to +150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C
Thermal Resistance, Junction to Lead	R <sub>JL</sub>	20	°C/W
Thermal Resistance, Junction to Ambient	R <sub>JA</sub>	100	°C/W
Typical Positive Temperature Coefficient for Breakdown Voltage	VBR/ T <sub>j</sub>	0.1	%/°C

### Maximum Rated Surge Waveform

Waveform	Standard	I <sub>pp</sub> (A)
2/10 us	GR-1089-CORE	300
8/20 us	IEC 61000-4-5	250
10/160 us	FCC Part 68	150
10/700 us	ITU-T, K20/K21	100
10/560 us	FCC Part 68	75
10/1000 us	GR-1089-CORE	50





**Electrical Characteristics** @ T<sub>A</sub> = 25 C unless otherwise specified

Part Number	Rated Repetitive Off-State Voltage	Off-State Leakage Current @ V <sub>DRM</sub>	Breakover Voltage	On-State Voltage @ I <sub>T</sub> = 1A	Breakover Current I <sub>BO</sub>		Holding Current I <sub>H</sub>		Off-State Capacitance
	V <sub>DRM</sub> (V)	I <sub>DRM</sub> (uA)	V <sub>BO</sub> (V)	V <sub>T</sub> (V)	Min (mA)	Max (mA)	Min (mA)	Max (mA)	C <sub>O</sub> (pF)
TB0640M	58	5	77	3.5	50	800	150	800	140
TB0720M	65	5	88	3.5	50	800	150	800	140
TB0900M	75	5	98	3.5	50	800	150	800	140
TB1100M	90	5	130	3.5	50	800	150	800	90
TB1300M	120	5	160	3.5	50	800	150	800	90
TB1500M	140	5	180	3.5	50	800	150	800	90
TB1800M	160	5	220	3.5	50	800	150	800	90
TB2300M	190	5	265	3.5	50	800	150	800	60
TB2600M	220	5	300	3.5	50	800	150	800	60
TB3100M	275	5	350	3.5	50	800	150	800	60
TB3500M	320	5	400	3.5	50	800	150	800	60

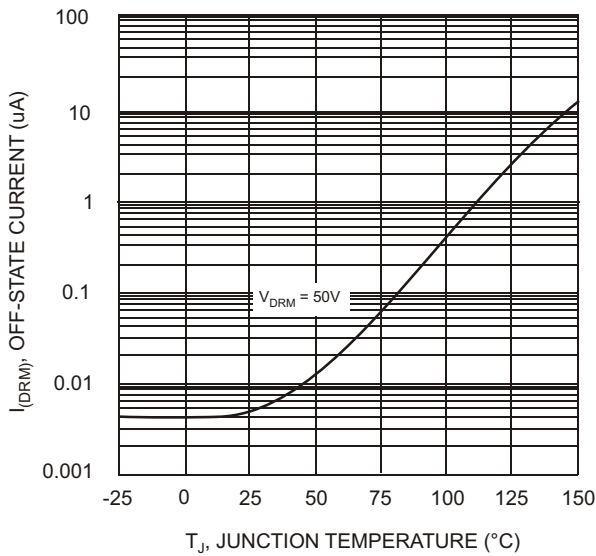


Fig. 1 Off-State Current vs. Junction Temperature

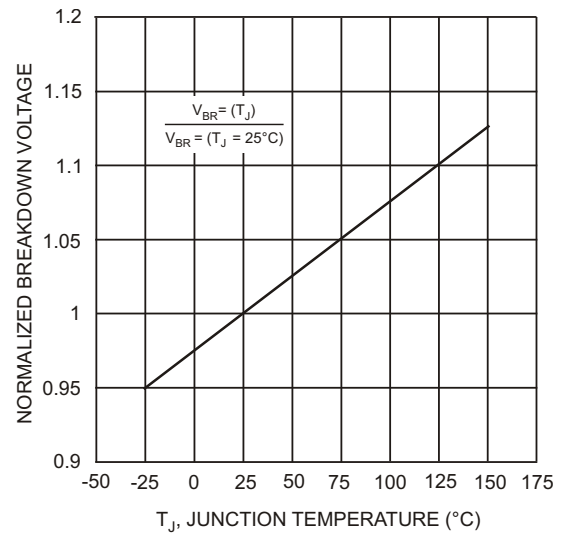


Fig. 2 Relative Variation of Breakdown Voltage vs. Junction Temperature

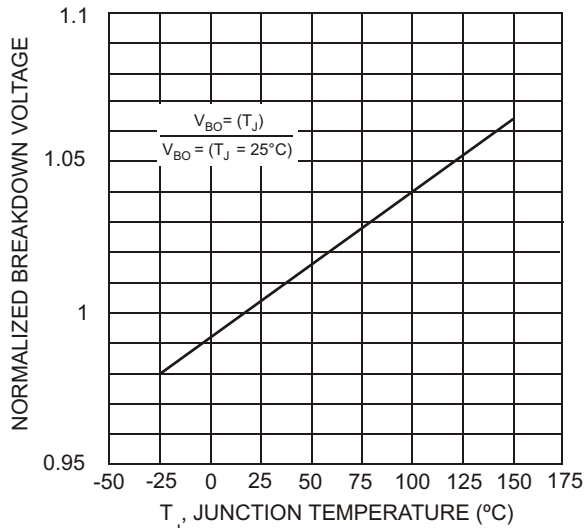


Fig. 3 Relative Variation of Breakover Voltage vs. Junction Temperature

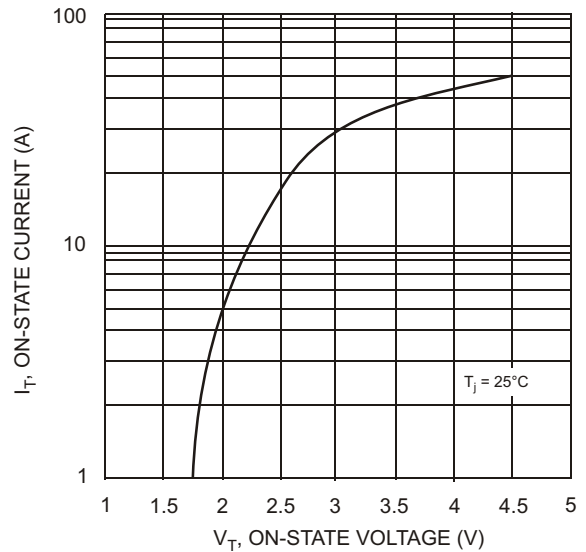


Fig. 4 On-State Current vs. On-State Voltage

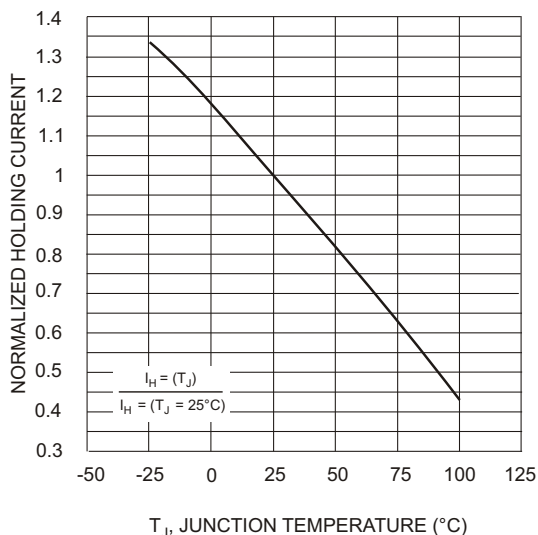


Fig. 5 Relative Variation of Holding Current vs. Junction Temperature

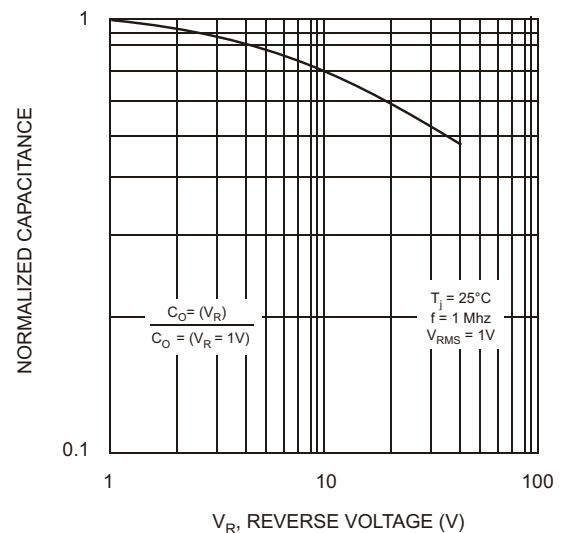


Fig. 6 Relative Variation of Junction Capacitance vs. Reverse Voltage Bias